

Electronic Supplementary Materials (ESI) for ChemComm.

Nanostructured silicon ferromagnet collected by a permanent neodymium magnet

Nanostructured Si (N-Si) was prepared by anodic electroetching of a p-type silicon wafer, which was sliced along the (100) plane, in 24% HF-ethanol solution.¹⁾ The electroetching was carried out under a current density of 100 mA cm^{-2} for 2, 10, 20, or 30 min. The powdered Si was scratched from the wafer with a spatula after the electroetching process, then subsequently rinsed with distilled water and dried in a vacuum oven. The Si wafer, crystalline powder from the Si wafer (C-Si), and the obtained samples, which were labelled as P-Si x ($x = 2, 10, 20$, and 30), were used for characterisation by X-ray diffraction (XRD) (UltimaIV, Rigaku), field emission scanning electron microscopy (FE-SEM) (JSM-6330F, JEOL), transmission electron microscopy (TEM) (H-7650, Hitachi), electron spin resonance (ESR) spectroscopy (JES-TE200, JEOL), X-ray photoelectron spectroscopy (XPS) (JPS-9010MX, JEOL), Raman spectroscopy (NRS-3100, JASCO), and SQUID magnetometry (MPMSR2, Quantum Design). XPS spectra were deconvoluted into seven peaks: Si (0), standard; Si (1+) Si_2O , -0.95 eV ; Si (2+) SiO , -1.75 eV ; Si (3+) Si_2O_3 , -2.48 eV ; Si (4+) SiO_2 , -3.90 eV ; Si (4+) thick SiO_2 ; Si (remaining atom).^{2,3)}

The magnetisation of P-Si x depended on the electroetching time (Fig. S1). The Si wafer exhibited a diamagnetic behaviour. Crystalline Si powder obtained from the Si wafer exhibited paramagnetism because of a small and positive magnetisation, which increases linearly with increasing magnetic field.

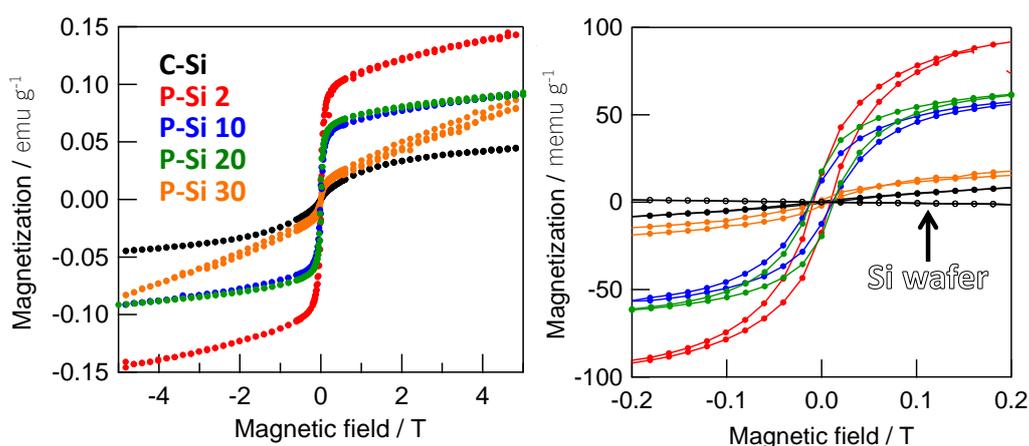


Fig. S1 Magnetisation curves of nanostructured silicon (P-Si x) obtained by the electroetching for various times (x min), ○: Si wafer; ●: C-Si (crystalline Si powder from Si wafer) at 2 K.

In P-Si x samples, a greater saturation magnetisation and coercivity were obtained at shorter electroetching times. The magnet was found to be ferromagnetic because the magnetic hysteresis was observed for all P-Si x samples, although the hysteresis loops were very small.

The temperature-dependence curves of a magnetic susceptibility (χ) of the Si wafer, C-Si and P-Si x are shown in Fig S2. The Si wafer is diamagnetic, with a negative, small, and constant χ . C-Si is also understood to be paramagnetic because of a positive and higher χ at low temperatures. As shown in Fig. S1, P-Si 2 exhibits the highest χ and is almost insensitive to temperature because it is ferromagnetic and its Curie temperature is greater than 150 K.

Fig. S3 shows the XRD patterns of the C-Si and P-Si x samples. The pattern of C-Si is a typical pattern of powdered Si. The patterns of P-Si 20 and 30 are similar to that of C-Si, although the peaks are broad because of the low crystallinity of the P-Si x samples. By contrast, the patterns of P-Si 2 and 10 differ slightly, showing a relatively strong peak assigned to the (400) plane. The intensity of this peak is attributed to the Si wafer being sliced along the (100) plane. The P-Si 2 and 10 samples had a residual structure oriented to the plane of the Si wafer because of the short electroetching time. The primary particle size was calculated from the patterns using the Scherrer equation: > 100 nm, 43 nm, 34 nm, 29 nm and 17 nm for C-Si, P-Si 2, P-Si 10, P-Si 20 and P-Si 30, respectively. Thus, the P-Si x samples are nanostructured solids.

The porosity of P-Si x samples was examined via N_2 gas adsorption measurements at 77 K; the results are shown in Fig. S4. The C-Si is found to be

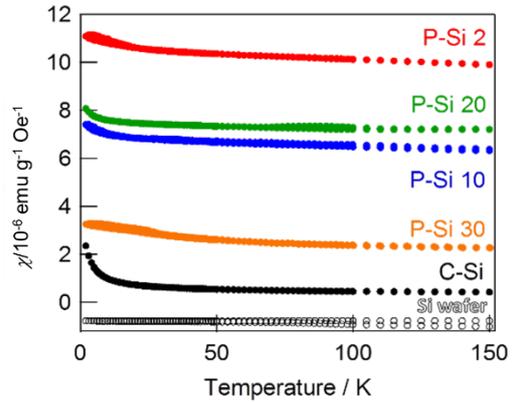


Fig. S2 Temperature dependence of magnetic susceptibility (χ) of nanostructured silicon (P-Si x) obtained by the electroetching for various times (x min). Magnetic field: 1 T.

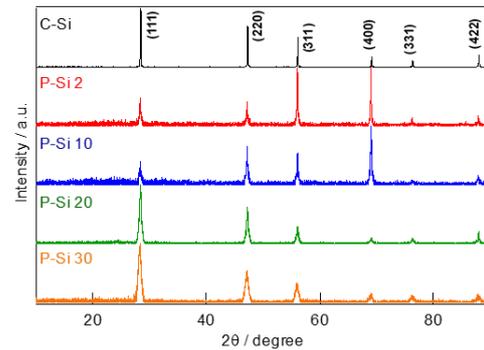


Fig. S3 XRD patterns of nanostructured silicon (P-Si x). X ray target: $Cu K\alpha$

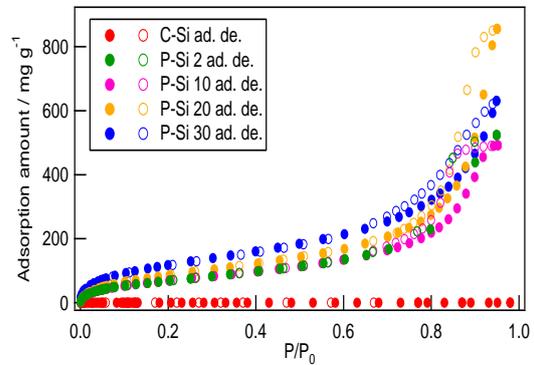


Fig. S4 N_2 adsorption isotherms of P-Si x . Closed: adsorption; open: desorption

nonporous, whereas P-Si x samples are mesoporous. The pore size distribution was obtained via Barrett–Joyner–Halenda (BJH) analysis of the isotherms (Fig. S5). All of the P-Si x samples have mesopores with pore diameters 10 nm or larger. The longer etching times caused a broad pore size distribution for pores larger than 15 nm. Thus, the electroetching produced nanopores on the Si crystal. The nanostructure should be intrinsic to the ferromagnetism of P-Si x .

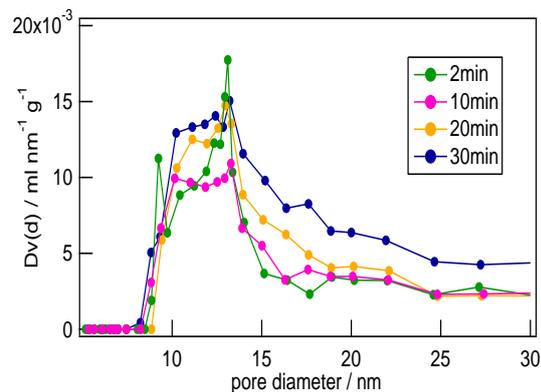


Fig. S5 Pore size distribution after the BJH analysis from the N_2 adsorption isotherms of P-Si x (Fig. S4).

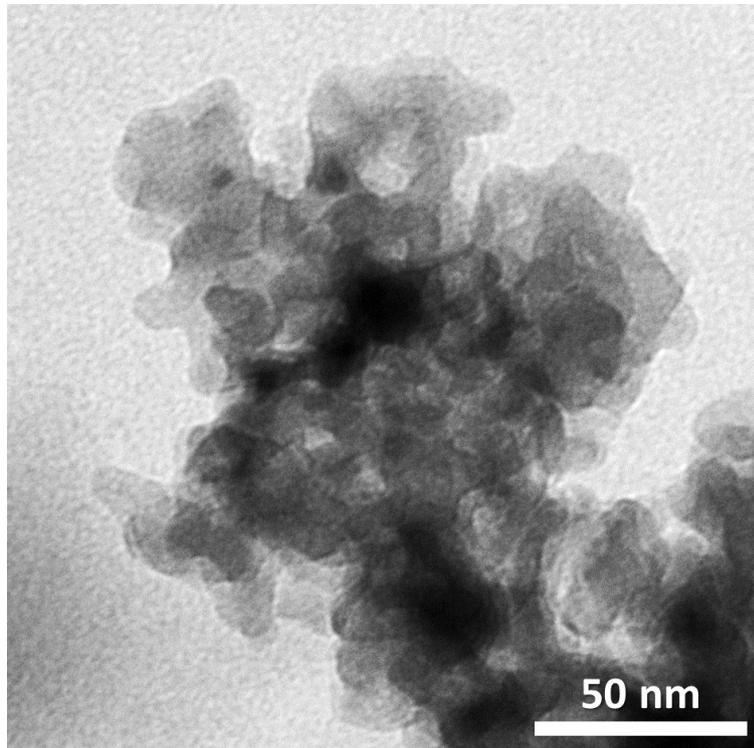


Fig. S6 TEM image of mN-Si.

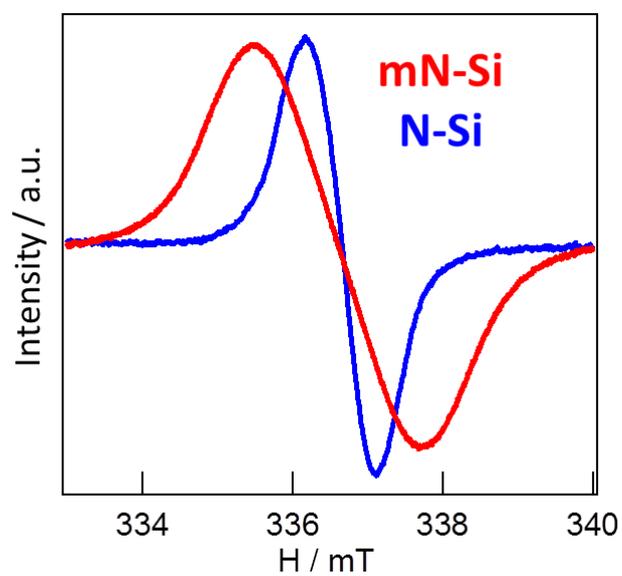


Fig. S7 Electron spin resonance (ESR) spectra of N-Si (blue) and mN-Si (red).

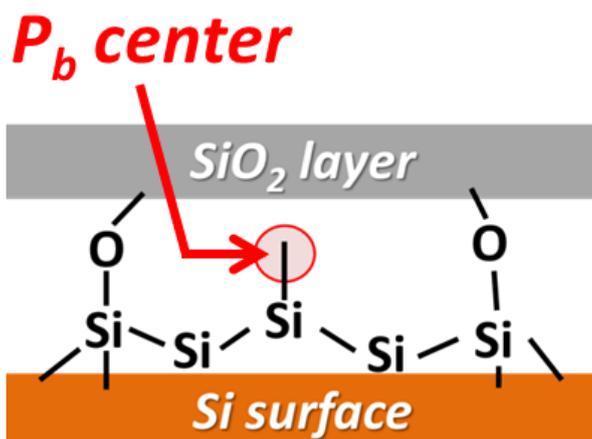


Fig. S8 Electron spin formed in a silicon nanostructure.⁴⁾

Surface states and nanostructures

Property (Apparatus)	mN-Si	N-Si
Magnetism (SQUID)	Superpara	Ferro
Unpaired electron (ESR)	Si dangling bond (pb center)	
Crystallite size (Raman, XRD)	Smaller (21.2 nm)	Larger (39.2 nm)
[SiO _x /Si2p] Peak area ratio (XPS)	36.6%	22.6%
[O1s/Si2p] Peak area ratio (XPS)	50.9%	23.6%

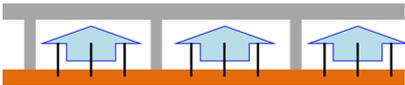
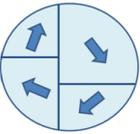
Surface state	<p>Dangling bonds are separated by oxygen atom</p> 	<p>The size of magnetic domain is larger than that of mN-Si</p> 
	<p>Crystal structure</p>  <p>Spin amount is higher, but spin interaction is weak</p>	 <p>Spin amount is lower, but spin interaction is strong</p>

Fig. S9 Surface states and nanostructures of N-Si and mN-Si.

References

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